

## DP2301S P-Channel MOSFET

#### General description

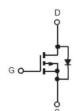
P-Channel MOSFET

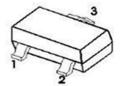
#### Features:

- V<sub>DS</sub> : -20V
- I<sub>D</sub>: -2.3A
- $R_{DS(ON)}$ ( at  $V_{GS}=-4.5V$ ) < 140 mohm
- $R_{DS(ON)}$ ( at  $V_{GS}=-2.5V$ ) < 210 mohm
- Trench Power MOSFET technology
- Low R<sub>DS(ON)</sub> @V<sub>GS</sub>= -4.5V
- High Current Handing Capability
- Halogen-free · RoHS Compliant

#### **Applications**

- DC/DC Converter for Portable Devices
- High-side Load Switch
- High Speed line Driver





- 1. Gate
- 2. Source
- 3. Drain

Package: SOT-23

#### **Device Marking Code:**

Device Type	Device Marking		
DP2301S	A1SHB		

#### Absolute Maximum Ratings (TA=25°Cunless otherwise noted)

Parameters	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-20	V
Gate-Source Voltage	V <sub>GS</sub>	V	
Continuous Drain Current	I <sub>D</sub>	-2.3	A
Pulsed Drain Current (note 1)	Ідм	-9	A
Maximum Power Dissipation	P <sub>D</sub>	1.0	W
Thermal Resistance from Junction to Ambient (note 2)	Rөja	125	°C/W
Junction and Storage Temperature	Tj., Tstg	-50~+150	°C

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# **DP2301S**



## **Electrical Characteristics** ( $T_J$ =25 $^{\circ}$ C unless otherwise noted)

Parameters	Symbol	Test Condition	Min	Тур	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V(BR)DSS	$V_{GS} = 0V, I_D = -250 \mu A$	-20			V
Zero gate voltage drain current	Idss	$V_{DS} = -20V, V_{GS} = 0V$			-1	μΑ
Gate-body leakage current	Igss	$V_{GS}=\pm\ 10V,\ V_{DS}=0V$			±100	nA
Gate threshold voltage (note 3)	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	-0.4	-0.6	-1.0	V
Drain-source on-resistance (note 3)	RDS(on)	$V_{GS} = -4.5V, I_D = -2A$		125	140	mΩ
		$V_{GS} = -3.3 \text{ V}, I_D = -1 \text{ A}$		140	170	mΩ
		$V_{GS} = -2.5V, I_D = -1A$		170	210	mΩ
Diode forward voltage (note 3)	Vsd	$I_{S}$ = - 1A, $V_{GS}$ = 0V		-0.83	-1.2	V
Dynamic Characteristics (note	24)	1				l
Input Capacitance	Ciss	$V_{DS}$ = -10V, $V_{GS}$ =0V, f =1MHz		177		pF
Output Capacitance	Coss			30		pF
Reverse Transfer Capacitance	Crss			25		pF
Switching Characteristics (not	te 4)					
Turn-on delay time	td(on)	$V_{DD}$ = -10V, $I_{D}$ = -2A, $R_{G}$ = 3.3 $\Omega$ , $V_{GS}$ = -4.5V		11		ns
Turn-on rise time	tr			32		ns
Turn-off delay time	td(off)			25		ns
Turn-off fall time	tf			38		ns
Total Gate Charge	Qg	V <sub>DS</sub> = -10V,I <sub>D</sub> =-2A, V <sub>GS</sub> =-4.5V		5.3		nC
Gate-Source Charge	Qgs			0.7		nC
Gate-Drain Charge	Qgd			1.4		nC

#### Note:

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<sup>1.</sup>Repetitive rating: Pluse width limited by maximum junction temperature

<sup>2.</sup>Surface Mounted on FR4 board,  $t \le 10$  sec.

 $<sup>3. \\</sup> Pulse \ test: Pulse \ width \leqslant 300 \\ \mu s, \ duty \ cycle \leqslant 2\%. \\ Guaranteed \ by \ design, \ not \ subject \ to \ production.$ 



#### **Typical Performance Characteristics**

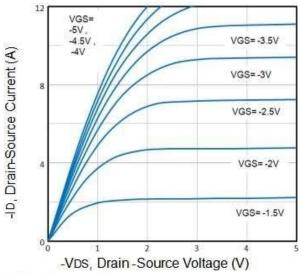


Fig1. Typical Output Characteristics

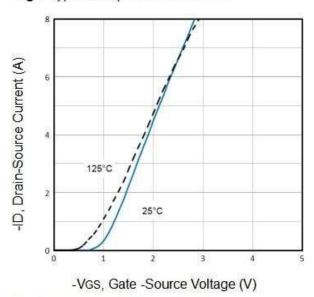
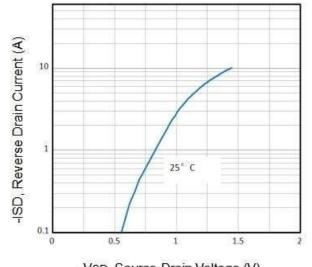


Fig3. Typical Transfer Characteristics



-VSD, Source-Drain Voltage (V)

Fig5. Typical Source-Drain Diode Forward Voltage

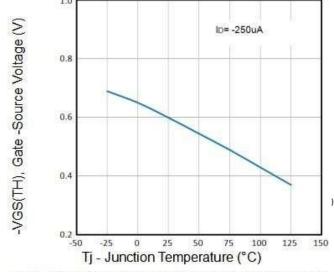


Fig2. Normalized Threshold Voltage Vs. Temperature

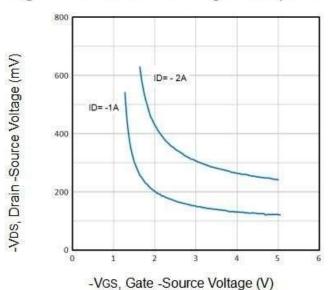


Fig4. Drain - Source Voltage vs Gate - Source Voltage

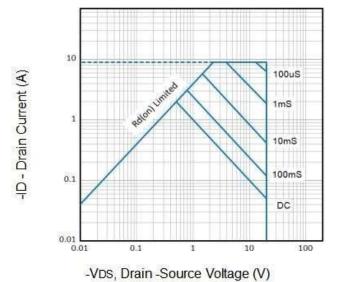
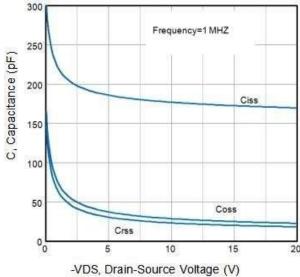
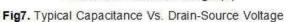


Fig6. Maximum Safe Operating Area

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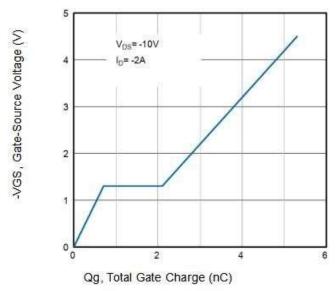
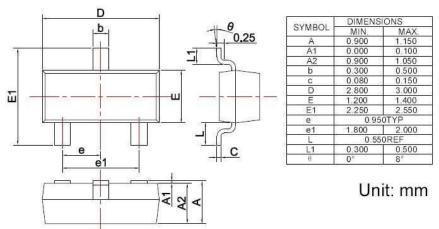
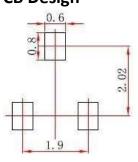


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

## **SOT-23 Package Outline Dimensions**



## **Precautions: PCB Design**



- Controlling dimension: in millimeters.
  General tolerance: ± 0.05mm.
- 3. The pad layout is for reference purposes only.

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